

2A, 0.25V Feedback Voltage Step-Down Switching Regulators for LED Driver

GENERAL DESCRIPTION

AX2007 consists of step-down switching regulator with PWM control. These devise include a reference voltage source, oscillation circuit, error amplifier, internal PMOS and etc.

AX2007 provides low-ripple power, high efficiency, and excellent transient characteristics. The PWM control circuit is able to the duty ratio linearly from 0 up to 100%. An enable function, an over current protect function and short circuit protect function are built inside, and when OCP or SCP happens, the operation frequency will be reduced. Also, an internal compensation block is built in to minimum external component count.

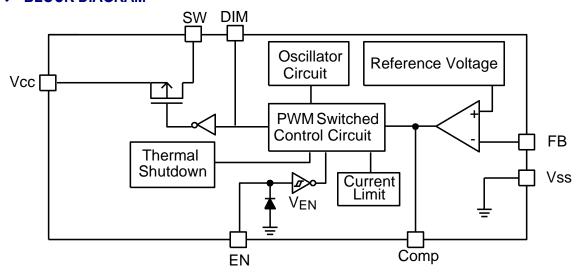
With the addition of an internal P-channel Power MOS, a coil, capacitors, and a diode connected externally, these ICs can function as step-down switching regulators. They serve as ideal power supply units for portable devices when coupled with the SOP-8L package, providing such outstanding features as low current consumption. Since this converter can accommodate an input voltage up to 23V, it is also suitable for the operation via an AC adapter.

FEATURES

- Input voltage: 3.6V to 23V
- Output voltage: 0.25V to V_{CC}
- LED Backlight and High Power LED Application
- Duty ratio: 0% to 100% PWM control
- Oscillation frequency: 330KHz typ.
- Enable/Disable function.
- Current Limit (CL), Thermal Shutdown and Short Circuit Protections (SCP).
- Built-in internal SW P-channel MOS.
- No output capacitor is stable.
- SOP-8L Pb-Free package.
- DIM Pin for Backlight Dimming.
- RoHS and Halogen free compliance

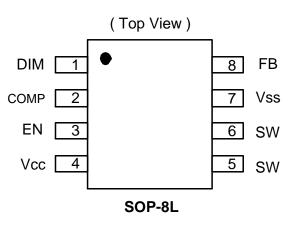


*** BLOCK DIAGRAM**



❖ PIN ASSIGNMET

The package of AX2007 is SOP-8L; the pin assignment is given by:



Name	Description				
FB	Feedback pin				
EN	Power-off pin H : normal operation(Step-down)				
DIM	L : Step-down operation stopped (All circuits deactivated)				
Comp	Compensation pin				
Vcc	IC power supply pin				
SW	Switch pin. Connect external inductor/diode here.				
Vss	GND pin				

❖ ORDER/MARKING INFORMATION

Order Information	Top Marking		
Package Type Packing S: SOP-8L Blank: Tube A: Taping	Logo ← AX 2 0 0 7 → Part number YYWWX → ID code: internal WW: 01~52 Year: 10=2010 11=2011 :: 19=2019		

❖ ABSOLUTE MAXIMUM RATINGS (at T_A=25°C)

Characteristics	Symbol	Rating	Unit
V _{CC} Pin Voltage	V_{CC}	V_{SS} - 0.3 to V_{SS} + 25	V
Feedback Pin Voltage	V_{FB}	V_{SS} - 0.3 to V_{CC}	V
ON/OFF Pin Voltage	V_{EN}/V_{DIM}	V_{SS} - 0.3 to V_{CC} + 0.3	V
Switch Pin Voltage	V_{SW}	V_{SS} - 0.3 to V_{CC} + 0.3	V
Power Dissipation	PD	Internally limited	mW
Storage Temperature Range	T _{ST}	-65 to +150	Ĉ
Operating Junction Temperature Range	T _{OP}	-40 to +125	Ŝ
Operating Supply Voltage	V_{OP}	+3.6 to +23	V
Thermal Resistance from Junction to case	θ_{JC}	60	°C/W
Thermal Resistance from Junction to ambient	θ_{JA}	120	°C/W

Note: θ_{JA} is measured with the PCB copper area(need connect to SW pins) of approximately 1 in²(Multi-layer).

❖ ELECTRICAL CHARACTERISTICS

(V_{IN} = 12V, T_A=25°C, unless otherwise specified)

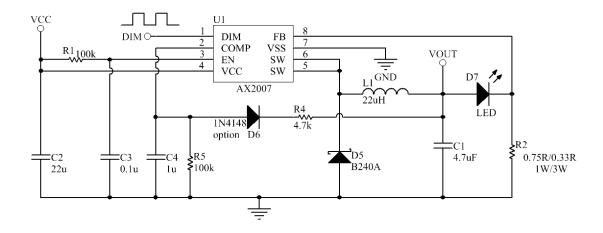
Characteristics	Symbol	Condit	ions	Min	Тур	Max	Units
Feedback Voltage	V_{FB}	I _{ОUТ} =0.2А		0.24	0.25	0.26	V
Quiescent Current	Icca	V _{FB} =1.2V force driver			3	5	mA
Feedback Bias Current	I _{FB}	I _{OUT} =0.1A		•	0.1	0.5	uA
Shutdown Supply Current	I _{SD}	V _{EN} =0V		-	2	10	uA
Switch Current	I _{SW}			2.5	ı	ı	Α
Line Regulation	Δ V _{OUT} /V _{OUT}	V _{CC} =5V~23\ I _{OUT} =0.2A	/,	-	1	2	%
Load Regulation	Δ V _{OUT} /V _{OUT}	I _{ΟUT} =0.1 to 2	?A	-	0.2	0.5	%
Oscillation Frequency	Fosc			260	330	400	KHz
EN Pin Logic input threshold	V_{SH}	High (regulator ON)		2.0	-	-	V
voltage	V _{SL}	Low (regulator OFF)		-	-	0.8	
EN Din Input Current	I _{SH}	V _{EN} =2.5V (ON)		ı	20	1	uA
EN Pin Input Current	I _{SL}	V _{EN} =0.3V (OFF)		-	-10	-	uA
DIM Pin Logic input threshold	shold V _{SH} High (Driver ON)		2.0	-	-	V	
voltage	V _{SL}	Low (Driver	OFF)	-	-	0.3	V
DIM Die leeut Ouwent	I _{SH}	V _{DIM} =2.5V (ON)		-	30	-	uA
DIM Pin Input Current	I _{SL}	V _{DIM} =0.3V (OFF)		-	-10	-	uA
Internal MOCELT D	Б	V _{CC} =5V, V _{FB} =0V		-	100	140	0
Internal MOSFET R _{DSON}	R _{DSON}	V _{CC} =12V, V _{FB} =0V		-	70	100	mΩ
Efficiency.	EFFI	V _{OUT} = 5V	I _{OUT} =1A	-	91	-	0/
Efficiency			I _{OUT} =2A	-	91	-	%
Thermal shutdown Temp T _{SD}		-	140	-	°C		

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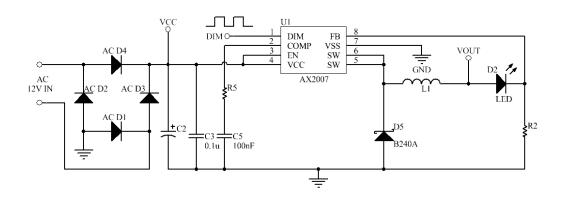
APPLICATION CIRCUIT

A. 1W/3W LED*1 for DC Input



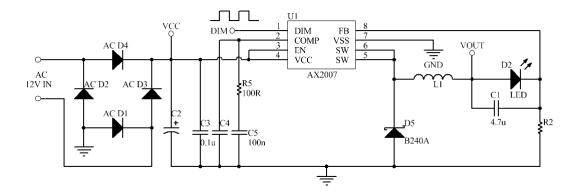
B. 1W/3W LED*1 for AC Input

(1) No Output Capacitor



I _{LED}	R2		C2	R5	L1
350mA	0.715Ω	87.5mW	100uF	0.22K	
750mA	0.333Ω	189mW	220uF	0.47K	68uH
1000mA	0.250Ω	250mW	330uF	0.47K	

(2) Add 4.7uF Output Capacitor



I _{LED}	R2		C2	C4	L1
350mA	0.715Ω	87.5mW	100uF		
750mA	0.333Ω	189mW	220uF	10nF	33uH
1000mA	0.250Ω	250mW	330uF		

*** FUNCTION DESCRIPTIONS**

PWM Control

The AX2007 consists of DC/DC converters that employ a pulse-width modulation (PWM) system. In converters of the AX2007, the pulse width varies in a range from 0 to 100%, according to the load current. The ripple voltage produced by the switching can easily be removed through a filter because the switching frequency remains constant. Therefore, these converters provide a low-ripple power over broad ranges of input voltage and load current.

Setting the I_{LED} Current

Application circuit item shows the basic application circuit with AX2007 adjustable output version. The external resistor sets the LED output current according to the following equation:

$$I_{LED} = \left(\frac{0.25V}{R2}\right)$$

Table 1 Resistor select for LED output current setting

		1
I _{LED}	R	2
350mA	0.715Ω	87.5mW
750mA	0.333Ω	189mW
1000mA	0.250Ω	250mW

RDS (ON) Current Limiting

The current limit threshold is setting by the internal circuit.

Compensation

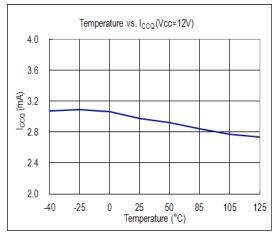
Please refer the table of application circuit. For DC input, the option circuit for compensation is connecting R4 and a 4148 diode to V_{OUT}. In order to protect short circuit and thermal shutdown release for LED.

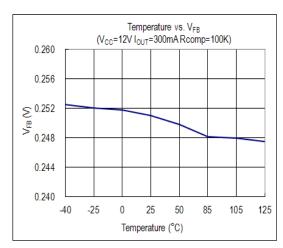
PCB layout guide

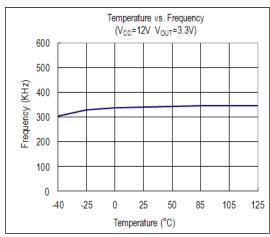
If you need low Tc and Tj or large PD (Power Dissipation), the dual SW pins (5 and 6) on the SOP-8L-EP package are internally connected to die pad, The PCB layout should allow for maximum possible copper area at the SW pins of the AX2007.

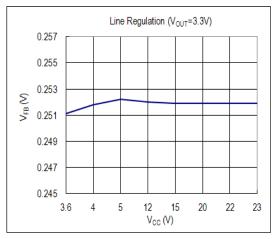


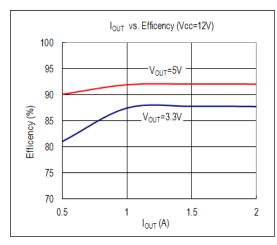
TYPICAL CHARACTERISTICS





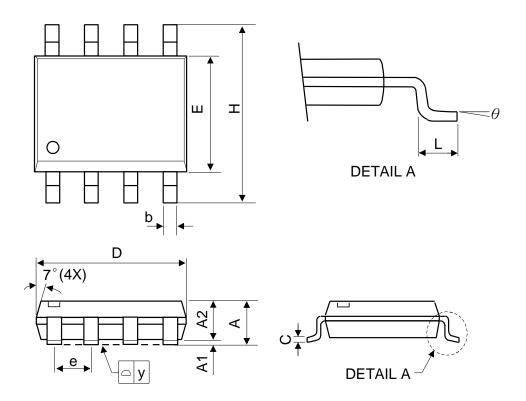








❖ PACKAGE OUTLINES



Symbol	Dimensions in Millimeters			Dimensions in Inches			
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.	
Α	-	-	1.75	-	-	0.069	
A1	0.1	-	0.25	0.04	-	0.1	
A2	1.25	-	-	0.049	-	-	
С	0.1	0.2	0.25	0.0075	0.008	0.01	
D	4.7	4.9	5.1	0.185	0.193	0.2	
Е	3.7	3.9	4.1	0.146	0.154	0.161	
Н	5.8	6	6.2	0.228	0.236	0.244	
L	0.4	-	1.27	0.015	-	0.05	
b	0.31	0.41	0.51	0.012	0.016	0.02	
е	1.27 BSC			(0.050 BSC		
у	-	-	0.1	-	-	0.004	
θ	00	-	80	00	-	80	

Mold flash shall not exceed 0.25mm per side

JEDEC outline: MS-012 AA



❖ CARRIER TAPE DIMENSION

